SCOPE:

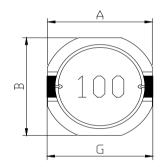
This specification applies to the Pb Free high current type SMD inductors for MSCDRI-6035LC-SERIES

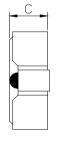
PRODUCT INDENTIFICATION

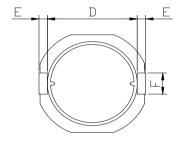
MSCDRI-6035LC- 100 M

- (1)
- 2
- 3 4
- **1** Product Code
- 2 Dimensions Code
- **3 Inductance Code**
- **4** Tolerance Code

(1) SHAPES AND DIMENSIONS







A: 6.30 Max. mm
B: 6.20 Max. mm
C: 3.50 Max. mm
D: 4.80 Ref. mm
E: 0.60 Ref. mm
F: 2.00 Ref. mm

mm

G: 6.40 Max.

(2) ELECTRICAL SPECIFICATIONS SEE TABLE 1

TEST INSTRUMENTS

L: HP 4284A PRECISION LCR METER (or equivalent)

RDC: CHROMA MODEL 16502 MILLIOHMMETER (or equivalent)

(3) CHARACTERISTICS

(3)-1 Operate temperature range -40° C \sim +125 $^{\circ}$ C (Including self temp. rise)

(3)-2 Storage temperature range -40° C $\sim +125^{\circ}$ C



TABLE 1

IABLL							
MAGLAYERS	Inductance	Percent	Test	Resistance	Rated Do	C Current	Marking
PT/NO.	L(µH)	Tolerance	Frequency	RDC(Ω) Max.	IDC1(A)	IDC2(A)	
MSCDRI-6035LC-2R0□	2.0	N	100kHz/0.25V	19m	3.00	4.14	2R0
MSCDRI-6035LC-2R7□	2.7	N	100kHz/0.25V	22m	2.69	3.91	2R7
MSCDRI-6035LC-3R3□	3.3	N	100kHz/0.25V	26m	2.57	3.52	3R3
MSCDRI-6035LC-4R7□	4.7	N	100kHz/0.25V	32m	2.08	3.15	4R7
MSCDRI-6035LC-6R2□	6.2	N	100kHz/0.25V	35m	1.84	3.02	6R2
MSCDRI-6035LC-6R8□	6.8	N	100kHz/0.25V	35m	1.84	3.02	6R8
MSCDRI-6035LC-8R2□	8.2	N	100kHz/0.25V	44m	1.54	2.64	8R2
MSCDRI-6035LC-100□	10	M,N	100kHz/0.25V	50m	1.49	2.46	100
MSCDRI-6035LC-120□	12	M,N	100kHz/0.25V	62m	1.28	2.17	120
MSCDRI-6035LC-150□	15	M,N	100kHz/0.25V	77m	1.10	1.93	150
MSCDRI-6035LC-180□	18	M,N	100kHz/0.25V	82m	1.05	1.90	180
MSCDRI-6035LC-220	22	M,N	100kHz/0.25V	0.106	0.97	1.62	220
MSCDRI-6035LC-270□	27	M,N	100kHz/0.25V	0.140	0.82	1.39	270
MSCDRI-6035LC-330□	33	M,N	100kHz/0.25V	0.162	0.76	1.28	330
MSCDRI-6035LC-390□	39	M,N	100kHz/0.25V	0.191	0.70	1.20	390
MSCDRI-6035LC-470□	47	M,N	100kHz/0.25V	0.208	0.68	1.12	470
MSCDRI-6035LC-560	56	M,N	100kHz/0.25V	0.257	0.60	1.00	560
MSCDRI-6035LC-680□	68	M,N	100kHz/0.25V	0.319	0.56	0.89	680
MSCDRI-6035LC-820□	82	M,N	100kHz/0.25V	0.420	0.47	0.76	820
MSCDRI-6035LC-101□	100	M,N	100kHz/0.25V	0.477	0.45	0.71	101

※ ☐ specify the inductance tolerance,M(±20%),N(±30%)

※ IDC1: Based on inductance change (△L/Lo: drop 30% Max.) @ambient temperature 25℃

IDC2: Based on temperature rise ($\triangle T: 40^{\circ}C$ TYP.)

Rated DC Current: The less value which is IDC1 or IDC2.



(4) RELIABILITY TEST METHOD MECHANICAL

TEST ITEM	SPECIFICATION	TEST DETAILS			
Substrate bending	∆L/Lo≦±5%	The sample shall be soldered onto the printed circuit board			
		in figure 1 and a load applied unitil the figure in the arrow			
	There shall be	direction is made approximately 3mm.(keep time 30 seconds)			
	no mechanical	PCB dimension shall the page 7/9			
	damage or elec-	F(Pressurization)			
	trical damage.	л			
		R5 45±2 45±2 10 20 R340			
		PRESSURE ROD figure-1			
Vibration	∆L/Lo≦±5%	The sample shall be soldered onto the printed circuit board			
		and when a vibration having an amplitude of 1.52mm			
	There shall be	and a frequency of from 10 to 55Hz/1 minute repeated should			
	no mechanical	be applied to the 3 directions (X,Y,Z) for 2 hours each.			
	damage.	(A total of 6 hours)			
Solderability	New solder	Flux (rosin, isopropyl alcohol{JIS-K-1522}) shall be coated			
Coldoralinity	More than 90%	over the whole of the sample before hard, the sample shall			
		then be preheated for about 2 minutes in a temperature of			
		130∼150℃ and after it has been immersed to a depth 0.5mm			
		below for 3±0.2 seconds fully in molten solder M705 with			
		a temperature of 245±5℃.			
		More than 90% of the electrode sections shall be couered			
		with new solder smoothly when the sample is taken out of			
		the solder bath.			

MECHANICAL

TEST ITEM	SPECIFICATION					
Resistance to	There shall be	Temperature profile of reflow soldering				
Soldering heat	no damage or					
(reflow soldering)	problems.	Soldering (Peak temperature 260±3°C 10 sec Pre-heating Slow cooling (Stored at room temperature) The specimen shall be passed through the reflow oven with the condition shown in the above profile for 1 time. The specimen shall be stored at standard atmospheric conditions for 1 hour, after which the measurement shall be made.				

ELECTRICAL

TEST ITEM	SPECIFICATION	TEST DETAILS
Insulation	There shall be	DC 100V voltage shall be applied across this sample of top
resistance	no other	surface and the terminal.
	damage or	The insulation resistance shall be more than $1 \times 10^8 \Omega$.
	problems.	
Dielectric	There shall be	AC 100V voltage shall be applied for 1 minute acrosset the top
withstand	no other	surface and the terminal of this sample
voltage	damage or	
	problems.	
Temperature	∆L/L20°C ≦±10%	The test shall be performed after the sample has stabilized in
characteristics	0~2000 ppm/℃	an ambient temperature of -20 to +85℃ ,and the value
		calculated based on the value applicable in a normal
		temperature and narmal humidity shall be △L/L20°C ≦±10%.



ENVIROMENT CHARACTERISTICS

TEST ITEM				SPECIFICATION			
High temperature	∆L/Lo≦±5%	The sampl	The sample shall be left for 96±4 hours in an atmospere with				
storage		a temperat	a temperature of 85±2℃ and a normal humidity.				
	There shall be	ere shall be Upon completion of the measurement shall be made after				the	
	no mechanical	sample ha	sample has been left in a normal temperature and normal				
	damage.	humidity for 1 hour.					
Low temperature	∆L/Lo≦±5%	The sampl	The sample shall be left for 96±4 hours in an atmosphere with				
storage		a temperat	a temperature of -25±3℃.				
	There shall be	Upon com	Upon completion of the test, the measurement shall be made				
	no mechanical	after the sa	after the sample has been left in a normal temperature and				
	damage.	normal hu	normal humidity for 1 hour.				
Change of	∆L/Lo≦±5%	The sampl	The sample shall be subject to 5 continuos cycles, such as shown				
temperature	in the table 2 below and then it shall				e subjected to stand	lard	
	There shall be	atmospher	atmospheric conditions for 1 hour, after which measurement				
	no other dama-	shall be m	shall be made.				
	ge of problems						
			table 2				
				Temperature	Duration		
			1	−25±3 ℃	30 min.		
				(Themostat No.1)			
			2	Standard	No.1→No.2		
				atmospheric			
			3	85±2 ℃	30 min.		
				(Themostat No.2)	30 111111.		
			4	Standard	No.2→No.1		
				atmospheric	140.2→140.1		
Moisture storage	∆L/Lo≦±5%	The sampl	le sl	nall be left for 96±4 hour	s in a temperature of	f	
		40±2℃ and	40±2 $^{\circ}$ C and a humidity(RH) of 90 \sim 95%.				
	There shall be	Upon com	Upon completion of the test, the measurement shall be made				
	no mechanical	after the sa	after the sample has been left in a normal temperature and				
	damage.	normal hu	normal humidity more than 1 hour.				

The sample shall be reflow soldered onto the printed circuit board in every test.

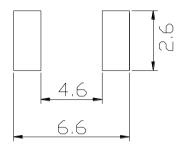


(5) LAND DIMENSION (Ref.)

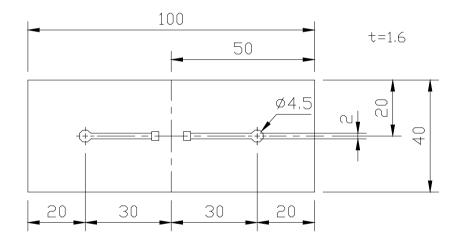
PCB: GLASS EPOXY t=1.6mm

(5)-1 LAND PATTERN DIMENSIONS

(STANDARD PATTERN) Unit: mm



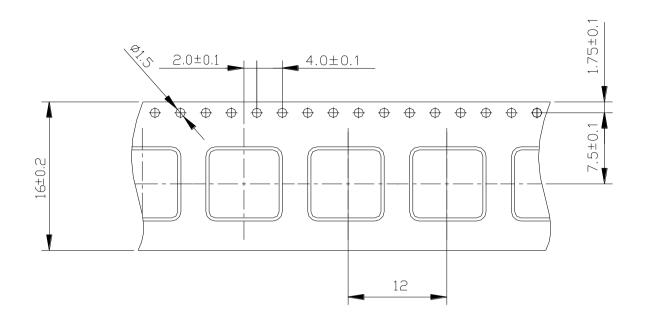
(5)-2 SUBSTRATE BENDING TEST BENDING TEST BOARD



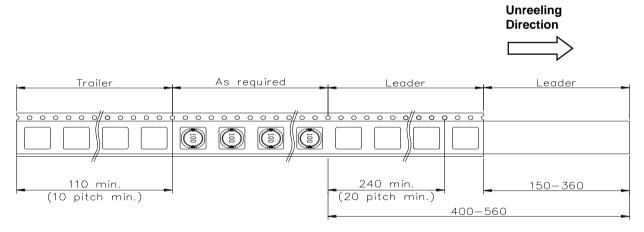


(6) PACKAGING

(6)-1 CARRIER TAPE DIMENSIONS (mm)

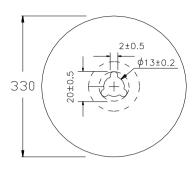


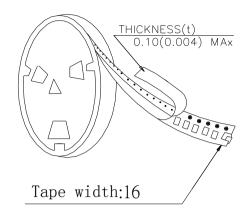
(6)-2 TAPING DIMENSIONS (mm)





(6)-3 REEL DIMENSIONS (mm)





(6)-4 QUANTITY

1500pcs/Reel

The products are packaged so that no damage will be sustained.